

# STEVAL-TDR004V1

RF power amplifier demonstration board using two SD2933 N-channel enhancement-mode lateral MOSFETs

#### Features

- Excellent thermal stability
- Frequency: 1.6 54 MHz
- Supply voltage: 48 V
- Output power: 400 W (typ.)
- Input power 10 W max.
- Efficiency: 57 % 76 %
- IMD at 300 WPEP < -26 dBc
- Load mismatch: 3:1 (all phases)

#### Description

The STEVAL-TDR004V1 demonstration board is an RF broadband power amplifier intended for linear or nonlinear operation over the 1.6 to 54 MHz band, using two SD2933 gold metallized Nchannel MOS field-effect transistors. The temperature compensating biasing circuit supports class B and class AB operation.

STEVAL-TDR004V1 is designed in cooperation with Specific RF Devices (Germany).



Table 1. Device summary

Order code

STEVAL-TDR004V1

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### 1 Electrical data

### 1.1 Maximum ratings

Symbol	Parameter	Value	Unit
P <sub>IN</sub>	Input power	16	W
P <sub>OUT</sub>	Output power	500	W
V <sub>DD</sub> <sup>(1)</sup>	Drain supply voltage	50	V
V <sub>GG</sub>	Gate biasing voltage	15	V
I <sub>DD</sub>	Drain current	20	Α
P <sub>DISS</sub>	Power dissipation	400	W

#### Table 2. Absolute maximum ratings

1.  $V_{GG}$  from 9 to 15 V and  $P_{IN}$  < 16 W



### 2 Electrical characteristics

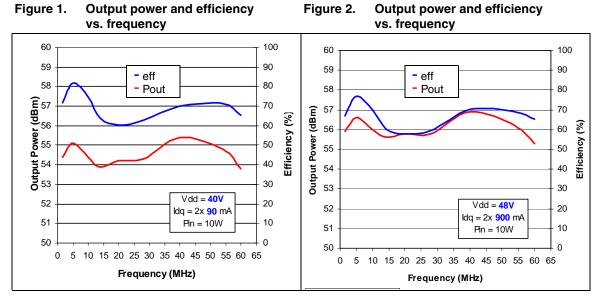
 $T_A = +25 \ ^{\circ}C, \ V_{DD} = 48 \ V, \ I_{DQ} = 2 \ x \ 900 \ mA$ 

Table 3. Electrical specification	Table 3.	Electrical specification
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Symbol	Test conditions	Min.	Тур.	Max.	Unit
Freq	Frequency range	1.6		54	MHz
P <sub>OUT</sub>	P <sub>IN</sub> = 10 W	300	400		W
Gain	P <sub>IN</sub> = 10 W	16.2 ±0.6dB			dB
ND	P <sub>IN</sub> = 10 W	57 - 76			%
H2	2 <sup>ND</sup> Harmonic @ P <sub>OUT</sub> = 300 W -26 / -49				dBc
H3	3 <sup>RD</sup> Harmonic @ P <sub>OUT</sub> = 300 W -13 / -58				dBc
VSWR	Load mismatch all phases @ $P_{OUT} = 300 W$			3:1	

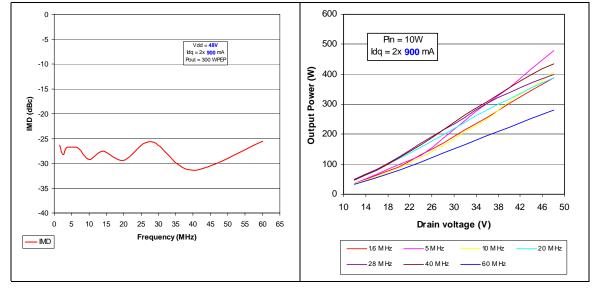


#### 3 Typical performance









57

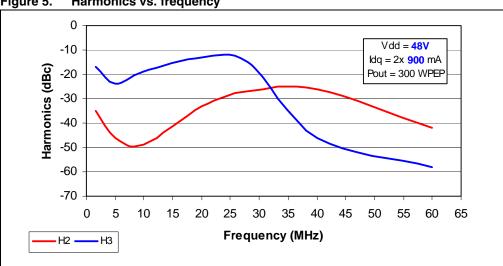


Figure 5. Harmonics vs. frequency

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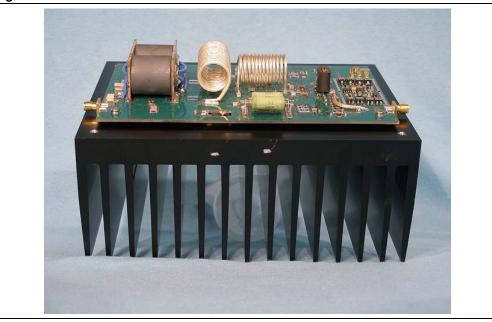


### 4 STEVAL-TDR004V1 amplifier photos











#### 5 STEVAL-TDR004V1 class of operation

- class B: a low bias point with ~100 mA per transistor
- class AB: a higher bias point with ~ 900 mA per transistor

To select a bias point, the STEVAL-TDR004V1 features a "BIAS" control port.

- The bias point is 2 x 100 mA if "BIAS" is left open. In this case a DC voltage of ~5 V is present
- The bias point is 2 x 900 mA if "BIAS" is connected to ground.

"PA\_ON" control port / ON-OFF bias current

- To switch on the biasing circuit, connect "PA\_ON" to ground.
- To switch off the biasing circuit, leave "PA\_ON" open.



#### 6 SD2933 mounting recommendations

#### 6.1 Mounting recommendations

- Ensure the holes in the heat sinks are free from burrs
- The minimum depth of tapped holes in heat sinks is 6 mm
- Use 4-40 UNC-2A cheese-head screws with a flat washer to more evenly distribute the joint pressure
- The minimum flatness of the mounting area is 0.02 mm
- Mounting area roughness should be less than 0.5 µm (micro)
- Avoid, as much as possible, the use of flux or flux solutions, as they can penetrate even hermetically sealed ceramic-capped transistors. Tin and wash the printed circuit board BEFORE mounting the power transistors, then solder the transistor leads without using flux
- Transistor leads may be tinned by dipping them full-length into a solder bath at a temperature of about 230 °C. No flux should be used during tinning
- Recommended heat sink compounds: WPSII (silicon-free) from Austerlitz Electronics, 340 from Dow Corning, etc.

#### 6.2 Mounting sequence

- Apply a thin layer of evenly distributed heat sink compound to the flange
- Position the device with flat washers in place
- Tighten the screws until finger tight (0.05 Nm)
- Further tighten the screws until the specified torque is reached
- For M174, M177 & M244 package types, torque should be a minimum of 0.6 Nm, and a maximum of 0.75 Nm.



Package	Description	Flongo	Loodfromo	Ceramic Plating		ing	Torque (N	
type	Description	riange	Flange Leadframe insulator Leads I		Flange	Min	Max	
M174	0.500 DIA 4L NON HERM W/FLANGE	Cu	ALLOY 42 (Fe58 / Ni42)	BeO (99.5% min)	Au (100 μ min) over Ni (100 μ min / 350 μ max)	Ni(100 μ min) + Pd (10 μ min)	0.6	0.75
M174 (Moly disk)	0.500 DIA 4L NON HERM W/FLANGE (MOLY DISK)	Cu-Mo- Cu	ALLOY 42 (Fe58 / Ni42)	BeO (99.5% min)	Au (100 μ min) over Ni (100 μ min / 350 μ max)	Ni(100 μ min) + Pd (10 μ min)	0.6	0.75
M177	0.550 DIA 4L NON HERM W/FLANGE	Cu-Mo- Cu	ALLOY 42 (Fe58 / Ni42)	BeO (99.5% min)	Au (60 μ min) over Ni (100 μ min / 350 μ max)	Au (100 μ min) over Ni (100 μ min / 350 μ max)	0.6	0.75
M244	2x 0.400x0.425 WIDE 2L LAP N/H FLANGE	W (85%) - Cu (15%)	ALLOY 42 (Fe58 / Ni42)	BeO(99.5 % min)	Au (60 μ min) over Ni (100 μ min / 350 μ max)	Au (60 μ min) over Ni (100 μ min / 350 μ max)	0.6	0.75

 Table 4.
 DMOS packages - list of materials

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## 7 Revision history

Table 5.Document revision history

Date	Revision	Changes		
27-Aug-2008	1	Initial release.		
18-Mar-2010	2	Updated description on cover page.		



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